

Multilayer Ceramic Chip Capacitors

CGA1A2X7R1C332K030BA



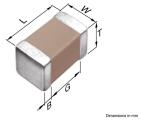






TDK item description CGA1A2X7R1C332KT****

Applications	Automotive Grade
Feature	General General (Up to 50V) AEC-Q200 AEC-Q200
Series	CGA1(0603) [EIA 0201]
Status	Production



Size		
Length(L)	0.60mm ±0.03mm	
Width(W)	0.30mm ±0.03mm	
Thickness(T)	0.30mm ±0.03mm	
Terminal Width(B)	0.10mm Min.	
Terminal Spacing(G)	0.20mm Min.	
Recommended Land Pattern (PA)	0.25mm to 0.35mm	
Recommended Land Pattern (PB)	0.20mm to 0.30mm	
Recommended Land Pattern (PC)	0.25mm to 0.35mm	

Electrical Characteristics		
Capacitance	3.3nF ±10%	
Rated Voltage	16VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	15000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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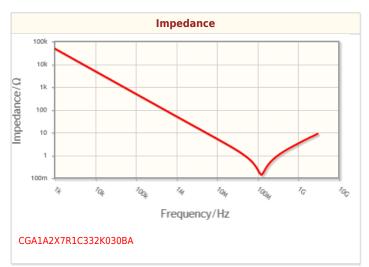


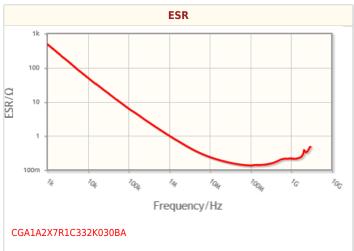


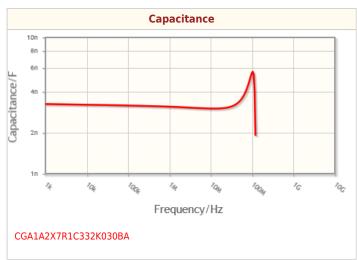


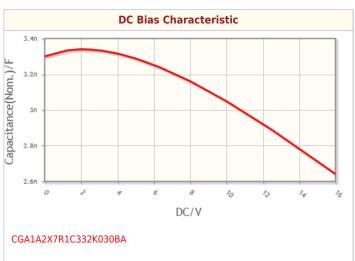


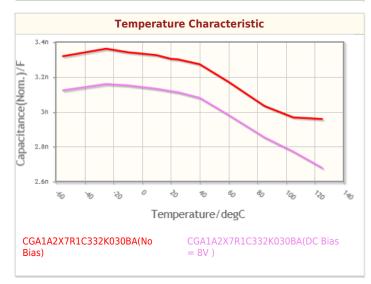
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

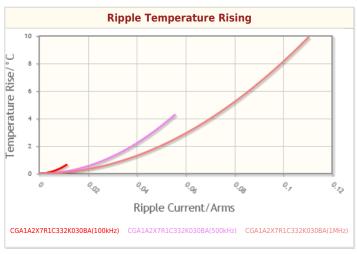












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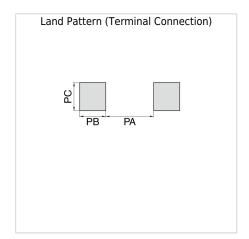








Associated Images



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